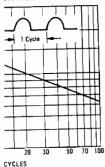
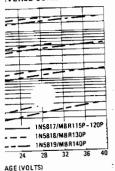
### TITIVE SURGE CURRENT



### VERSE CURRENT



### ENCY OPERATION

tky rectifier is the result of not subject to jucntion diode itents due to minority carrier factory circuit analysis work consisting of an ideal diode in (See Figure 11.)

ments show that operation will ahertz. For example, relative approximately 70 per cent at rto RMS power in the load is infect rectification would yield rever, in contrast to ordinary irm efficiency is not indicative of reverse current flow through i the dc output voltage.

### MOTOROLA I SEMICONDUCTOR I TECHNICAL DATA

### **Designers Data Sheet**

### **AXIAL LEAD RECTIFIERS**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v<sub>F</sub>
- Low Stored Charge, Majority
- Low Power Loss/High Efficiency
- Carrier Conduction

### Designer's Data for Worst-Case Conditions

The Designers—Data sheets permit the design of most circuits entirely from the information presented. Limit curves—representing boundaries on device characteristics—are given to facilitate worst-case design.

### \*MAXIMUM RATINGS

Rating	Symbol	1N5820 MBR320P	1N5821 MBR330P	1N5822 MBR340P	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	20	30	40	٧
Non-Repetitive Peak Reverse Voltage	VRSM	24	36	48	٧
RMS Reverse Voltage	VR(RMS)	14	21	28	V
Average Rectified Forward Current(2)  VR (equiv) ≤ 0.2 VR(dc), TL = 95°C  (R <sub>Ø JA</sub> = 28°C/W, P.C. Board  Mounting, see Note 2)	10	-	3.0 —	-	Α
Ambient Temperature Rated V <sub>R(dc)</sub> , P <sub>F(AV)</sub> = 0 R <sub>0 JA</sub> = 28°C/W	TA	90	85	80	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase 60 Hz, TL = 75°C)	<sup>I</sup> FSM		(for one cy	cle)	A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	TJ, Tstg	-	-65 to + 125	- <b>-</b>	°C
Peak Operating Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	-	150 —		°C

### \*THERMAL CHARACTERISTICS (Note 2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R <sub>B</sub> JA	2B	oC/M

### \*ELECTRICAL CHARACTERISTICS (TL = 25°C unless otherwise noted) (2

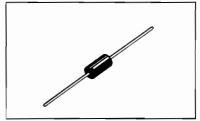
Characteristic	Symbol	1N5820	1N5821	1N5822	MBRP	Unit
Maximum Instantaneous	٧F					
Forward Voltage (1)				ſ	1	
(i <sub>F</sub> = 1.0 Amp)		0.370	0.380	0.390	0.400	
(iF = 3.0 Amp)		0.475	0.500	0.525	0.550	
(ip = 9.4 Amp)		0.850	0.900	0.950	0.950	
Maximum Instantaneous	iR					mA
Reverse Current @ Rated				ſ	' I	
dc Voitage (1)	[					
TL = 25°C	l	2.0	2.0	2.0	2.0	
TL = 100°C	!	20	20	20	20	

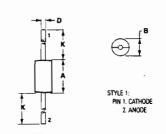
- (1) Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0%.
- (2) Lead Temperature reference is cathode lead 1/32" from case.
- \*Indicates JEDEC Registered Data for 1N5820-22.

### 1N5820 MBR320P 1N5821 MBR330P 1N5822 MBR340P

### SCHOTTKY BARRIER RECTIFIERS

3.0 AMPERES 20, 30, 40 VOLTS





### NOTES:

- DIMENSIONING & TOLERANCING PER ANSI Y14.5, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	MILLIM	MILLIMETERS		HES
DIM	MIN	MAX	MIN	MAX
A	9.40	9.65	0.370	0.380
8	4.83	5.33	0.190	0.210
D	1.22	1.32	0.048	0.052
K	25.40	_	1.000	_

CASE 267-03 PLASTIC

### MECHANICAL CHARACTERISTICS

CASE Transfer molded plastic
FINISH
corrosion-resistant and the terminal
leads are readily solderable
POLARITY Cathode indicated by polarity band
MOUNTING POSITIONS Any
SOLDERING

3

# 1N5820, 1N5821, 1N5822, MBR320P, MBR330P, MBR340P

TAINMEN — TJINMEN — REJAP FILAV) — REJAP RIAV) (1)
where TJINMEN — Selections of proceeds enhance intropression
TJINMEN — Meanment entous entering entous
TJINMEN — SELECTION TO SELECTION — SELECTION

Figures 1, 2, and 3 permit baser use of equation (1) by taking reverse power dissipation and thermal runaway into consideration.

The figures solve for a reference temperature as determined by equation (2). TR - TJ(max) - ReJAPR(AV)

Substituting equation (2) into equation (1) yields:

TA(max) = TR - RejAPF(AV) (2) Integetion of equation (2) and (3) reveals that TR is the integetion of equation (2) and (3) reveals that if is the ambient temperatura is which thermal univariest of where T = 128°C, when forward power is area, The stratistical from the poundary condition to the other is evident on the current of Figures 1, 2, and 3 as a difference in the rare of change of the

isope in the vicinity of 119°C. The date of Figure 1, 2, and 3 is based upon dc conditions. For use in common rectifier creation. Table 1 indicates augmented factors for an equivalent dc voltage to use for conservative design, that it: EXAMPLE: Find TA(mas) for INSS2I operated in a 12-rott of a supply unin a bridge curet with capacitive filter such that foc = 2.0 A ligraxy; = 10, input Voltage = 10 V [rms], R3.A = 40°C/W. Step 1. Find V Request Read F = 0.65 from Table 1. V Request = 0.65 from Table 1. Step 2. Find Tq from Figure 2. Read Tq = 100°C. By = 9.2 mod Figure 8. "Read Figure 9. "Read Figure 8. "Read Figure 9." Read Figure 9." The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes # (AV) - 10 and IF(AV) - 1.0 A. VR(aquiv) = V(FM) X F

occurs or where "Yvalues given are for the 196311, forwer in sighility lower for the nation from one 119620 because of its lower forward voltage, and higher for the 1196202. Variations will be smiler for the MBR-prefix devices, if chamge of the using PrACTOR Figure 7.

TABLE 1 – VALUES FOR FACTOR F Step 4. Find TA(max) from equation (3). TA(max) = 108 - (0.85) (40) = 74°C.

Helf Weve Bridge Capacitive Resistive Capacitive

| Sine Weve | 0.5 | 1.3 | 0.5 | 0.65 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | 0.00 | 1.5 | FIGURE 1 - MAXIMUM REFERENCE TEMPERATURE

VA. REVERSE VOLTAGE (VOLTS)

FIGURE 3 - MAXIMUM REFERENCE TEMPERATURE

VR. REVERSE VOLTAGE (VOLTS)



FIGURE 2 - MAXIMUM REFERENCE TEMPERATURE

FIGURE 4 - STEADY-STATE THERMAL RESISTANCE VR. REVERSE VOLTAGE (VOLTS)

0.3

L. LEAD LENGTH (INCHES)

## 1N5820, 1N5821, 1N5822, MBR320P, MBR330P, MBR340P

### FIGURE 5 - THERMAL RESPONSE

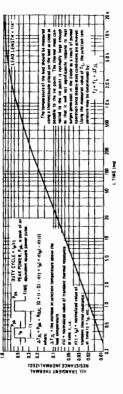
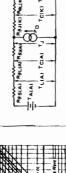
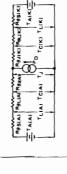


FIGURE 6 - FORWARO POWER DISSIPATION



NOTE 3 - APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits function to lead thermal restracted for any monthing configuration to be found. For a given fortal lead infinity, lowest values occur when one side of the restriction for the configuration of the restriction of

T<sub>C</sub> = Cese Temperature TA - Ambient Temperature

FIGURE 7 - FORWARD POWER DISSIPATION

MRR3209.340

IFIAV), AVERAGE FORWARD CURRENT (AMP)

T<sub>1</sub> \* Leaf Tamperature
T<sub>1</sub> \* Land Tamperature
T<sub>2</sub> \* Junotiton Tamperature
R<sub>2</sub> \* Therma Resistance, Heat Sink to Ambount
R<sub>3</sub> \* Therma Resistance, Lead to Heat Sink
R<sub>4</sub> \* Therma Resistance, Lead

(Subscript) (A) and (K) refer to anode and cathode sides, respectively. Valuet for Internal resistance components are. Rg\_L = 42°C;Win vipolesity and 48°C;Win maximum Rg\_L = 40°C;Wi vipolesity and 18°C;Win maximum P. \* Reverse Power Dissipation

The maximum lead temperature may be found as follows: TL - TJIMax) - ATJL where ATJL . Rejl. PD

Mounting Method 3
P.C. Board with
with 2.1/2" × 2.1/2"
copper surface Mounting Method 1 P.C. Board where available copper surface is small. Mounting Method 2 Vactor Push-In Terminals T-28 Date shown for thermal resistance junction-to-ambient (Fig.JA) for the mountings shown is to be used as typical guidaline values cannot be measured, or in case the tie point temperature cannot be measured.

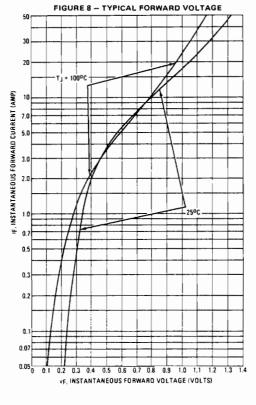
FLAY). AVERAGE FORWARD CURRENT (AMP)

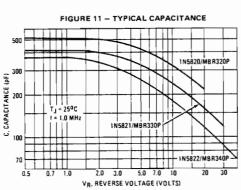
NOTE 2 - MOUNTING DATA

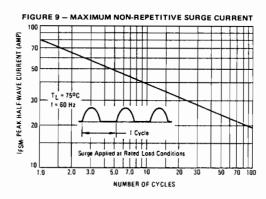
TVPICAL VALUES FOR ROJA IN STILL AIR

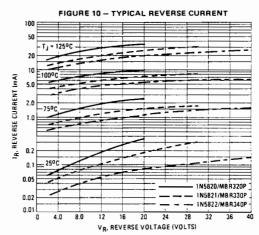
Board Ground Plans 7, -1,2

### 1N5820, 1N5821, 1N5822, MBR320P, MBR330P, MBR340P









### NOTE 4 - HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored cherge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)